## CRST040N10N, CRSS037N10N

SkyMOS1 N-MOSFET 100V,  $3.3m\Omega$ , 120A

#### **Features**

- Uses CRM(CQ) advanced SkyMOS1 technology
- Extremely low on-resistance R<sub>DS(on)</sub>
- Excellent Q<sub>q</sub>xR<sub>DS(on)</sub> product(FOM)
- Qualified according to JEDEC criteria

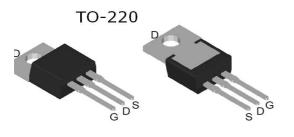
## **Product Summary**

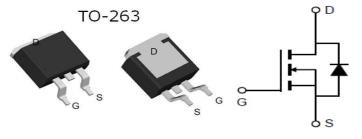
$V_{DS}$	100V
R <sub>DS(on)</sub>	$3.3 m\Omega$
$I_{D}$	120A

## **Applications**

- Motor control and drive
- Battery management
- UPS (Uninterrupible Power Supplies)

100% Avalanche Tested





CRST040N10N

CRSS037N10N

#### **Package Marking and Ordering Information**

Part #	Marking	Package	Packing	Reel Size	Tape Width	Qty
CRSS037N10N	-	TO-263	Tube	N/A	N/A	50pcs
CRST040N10N	-	TO-220	Tube	N/A	N/A	50pcs

#### **Absolute Maximum Ratings**

Parameter	Symbol	Value	Unit
Drain-source voltage	$V_{DS}$	100	V
Continuous drain current			
T <sub>C</sub> = 25°C (Silicon limit)	$I_{D}$	183	Α
T <sub>C</sub> = 25°C (Package limit)	ı <sub>D</sub>	120	
T <sub>C</sub> = 100°C (Silicon limit)		116	
Pulsed drain current ( $T_C = 25$ °C, $t_p$ limited by $T_{jmax}$ )	${ m I_{D~pulse}}$	480	Α
Avalanche energy, single pulse (L=0.5mH, Rg=25 $\Omega$ )	E <sub>AS</sub>	300	mJ
Gate-Source voltage	$V_{GS}$	±20	V
Power dissipation ( $T_C = 25^{\circ}C$ )	P <sub>tot</sub>	227	W
Operating junction and storage temperature	$T_{j}$ , $T_{stg}$	-55+150	°C





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## **Thermal Resistance**

Parameter	Symbol	Max	Unit
Thermal resistance, junction – case.	$R_{thJC}$	0.55	°C/W
Thermal resistance, junction – ambient(min. footprint)	$R_{thJA}$	62	- C/ VV

## Electrical Characteristic (at Tj = 25 °C, unless otherwise specified)

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Parameter	Symbol	min.	typ.	max.	Unit	Test Condition
Static Characteristic						
Drain-source breakdown voltage	BV <sub>DSS</sub>	100	-	-	V	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA
Gate threshold voltage	V <sub>GS(th)</sub>	2	3	4	V	$V_{DS}=V_{GS}$ , $I_{D}=250$ uA
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.05	1 5	μА	$V_{DS}$ =100V, $V_{GS}$ =0V $T_{j}$ =25°C $T_{j}$ =125°C
Gate-source leakage current	$I_{GSS}$	-	10	100	nA	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	3.3	4.0 3.7	mΩ	V <sub>GS</sub> =10V, I <sub>D</sub> =50A TO-220 TO-263
Transconductance	g <sub>fs</sub>	-	108	-	S	$V_{DS}=5V,I_{D}=50A$

Input Capacitance	C <sub>iss</sub>	-	6920	-			
Output Capacitance	C <sub>oss</sub>	-	1026	-	pF	$V_{GS}=0V$ , $V_{DS}=50V$ ,	
Reverse Transfer Capacitance	C <sub>rss</sub>	-	33.4	-		f=1MHz	
Gate Total Charge	$Q_{G}$	-	117	-			
Gate-Source charge	$Q_{gs}$	-	40	-	nC	$V_{GS}$ =10V, $V_{DS}$ =50V, $I_{D}$ =50A, f=1MHz	
Gate-Drain charge	$Q_{gd}$	-	37	-			
Turn-on delay time	t <sub>d(on)</sub>	-	48	-			
Rise time	t <sub>r</sub>	-	56	-	nc	$V_{GS} = 10V, V_{DS} = 50V, R_G = 3.0\Omega$	
Turn-off delay time	t <sub>d(off)</sub>	-	75	-	ns		
Fall time	t <sub>f</sub>	-	33	-			
Gate resistance	$R_G$	-	2.6	-	Ω	$V_{GS}$ =0V, $V_{DS}$ =0V, $f$ =1MHz	





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## **Body Diode Characteristic**

Parameter	Symbol		Value		Unit	Test Condition
	Syllibol	min.	typ.	max.	Oilit	rest condition
Body Diode Forward Voltage	$V_{SD}$	ı	0.85	1.3	>	V <sub>GS</sub> =0V,I <sub>SD</sub> =50A
Body Diode Reverse Recovery Time	t <sub>rr</sub>	-	60	-	ns	I <sub>F</sub> =20A, dI/dt=500A/μs
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	ı	560	-	nC	I <sub>F</sub> =20A, dI/dt=500A/μs





## **Typical Performance Characteristics**

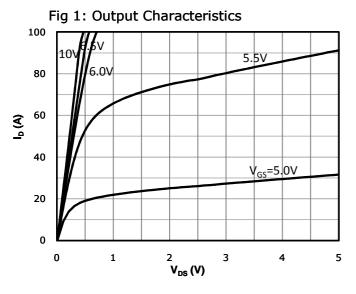


Fig 2: Transfer Characteristics 100  $V_{DS}=5V$ 80 60 آ ا 125°C 25°C 40 20 0 7 0 1 2 5 6 8 3  $V_{GS}(V)$ 

Fig 3: Rds(on) vs Drain Current and Gate Voltage 5.0 4.5 R<sub>DS(on)</sub> (mΩ) 4.0  $V_{GS} \neq 10V$ 3.5 3.0 2.5 2.0 10 20 30 40 50 60 70 80 90 100  $I_D(A)$ 

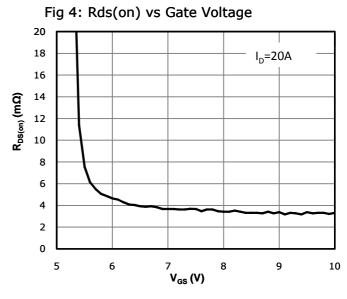


Fig 5: Rds(on) vs. Temperature

2.0 V<sub>GS</sub>=10V 1.8  $I_D = 50A$ 1.6 R<sub>DS(on)</sub>\_Normalized 1.4 1.2 1.0 0.8 0.6 0.4 25 75 125 150 175 Tj - Junction Temperature (°C)

Fig 6: Capacitance Characteristics 10000 Ciss C - Capacitance (PF) 1000 Coss 100  $V_{GS}=0V$ Crss f=1MHz 10 40 100 0 20 60 80 V<sub>DS</sub> (V)



0

20

40

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80

100

120

Fig 8: Body-diode Forward Characteristics 100 Is - Diode Current(A) 10 125°C 25 °C 1 0.1 0.01 0.2 0.6 0.8 1 0 0.4 1.2 V<sub>SD</sub> - Diode Forward Voltage(V)

Fig 9: Power Dissipation

250
200
150
100
50
0
25 50 75 100 125 150

Tc - Case Temperature (°C)

Qg (nC)

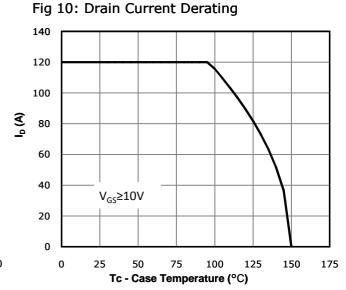
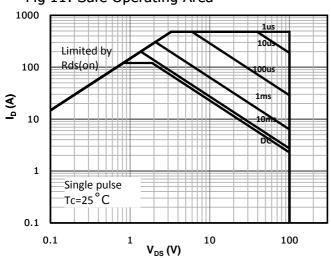


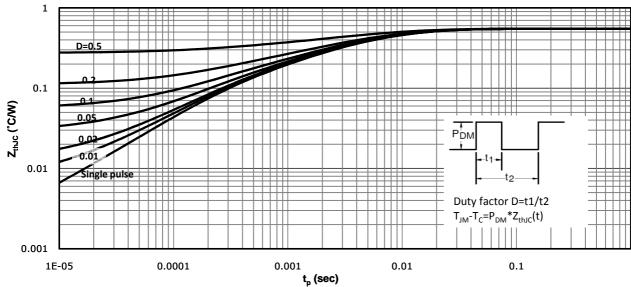
Fig 11: Safe Operating Area





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Fig 12: Max. Transient Thermal Impedance

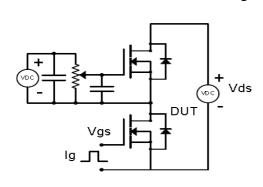


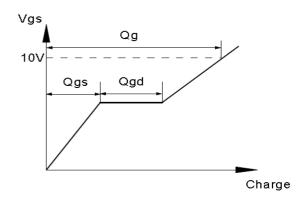




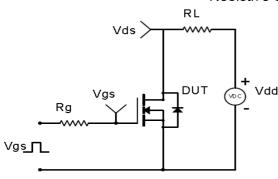
### **Test Circuit & Waveform**

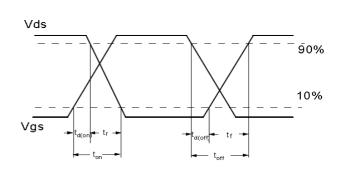
#### Gate Charge Test Circuit & Waveform



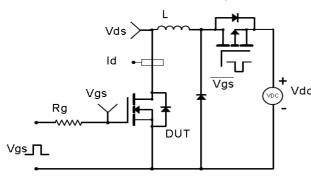


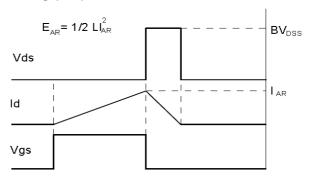
Resistive Switching Test Circuit & Waveforms



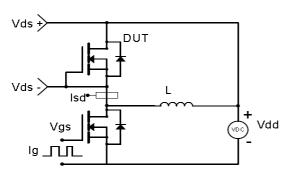


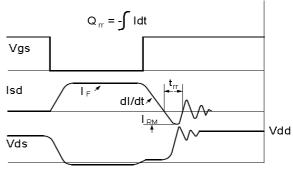
#### Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





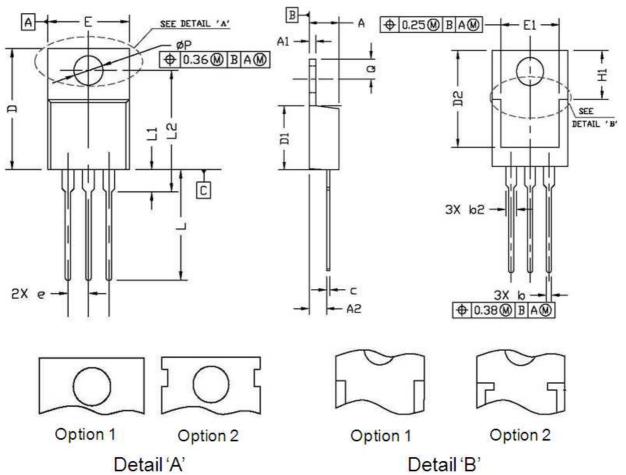
#### Diode Recovery Test Circuit & Waveforms







Package Outline: TO-220-3L

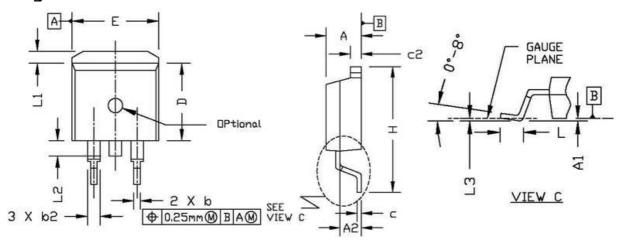


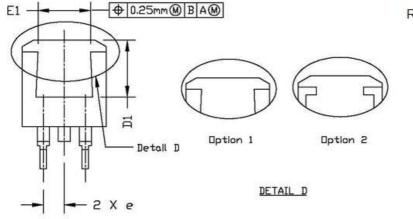
Comple ed	Dimensions I	n Millimeters	Dimensions	In Inches
Symbol	Min.	Max.	Min.	Max.
Α	4.30	4.80	0.169	0.189
A1	1.20	1.45	0.047	0.057
A2	2.20	2.90	0.087	0.114
b	0.69	0.95	0.027	0.037
b2	1.00	1.60	0.039	0.063
С	0.33	0.65	0.013	0.026
D	14.70	16.20	0.579	0.638
D1	8.59	9.65	0.338	0.380
D2	11.75	13.60	0.463	0.535
е	2.54 BSC.		0.100	BSC.
E	9.60	10.60	0.378	0.417
E1	7.00	8.46	0.276	0.333
H1	6.20	7.00	0.244	0.276
L	12.60	14.80	0.496	0.583
L1	2.70	3.80	0.106	0.150
L2	12.13	16.50	0.478	0.650
Q	2.40	3.10	0.094	0.122
Р	3.50	3.90	0.138	0.154

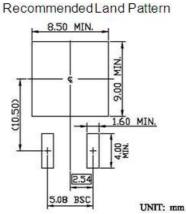


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## Package Outline: TO-263







Sumb al	Dimensions 1	n Millimeters	Dimension	s In Inches	
Symbol	Min.	Max.	Min.	Max.	
А	4.30	4.86	0.169	0.191	
A1	0.00	0.25	0.000	0.010	
A2	2.34	2.79	0.092	0.110	
b	0.68	0.94	0.027	0.037	
b2	1.15	1.35	0.045	0.053	
С	0.33	0.65	0.013	0.026	
c2	1.17	1.40	0.046	0.055	
D	8.38	9.45	0.330	0.372	
D1	6.90	8.17	0.272	0.322	
е	2.54 BSC.		0.100	.100 BSC.	
Е	9.78	10.50	0.385	0.413	
E1	6.50	8.60	0.256	0.339	
Н	14.61	15.88	0.575	0.625	
L	2.24	3.00	0.088	0.118	
L1	0.70	1.60	0.028	0.063	
L2	1.00	1.78	0.039	0.070	
L3	0.00	0.25	0.000	0.010	





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## **Revision History**

Revison	Date	Major changes
1.0	2018-02-09	Release of formal version.
2.0	2019-05-28	Supplement package outline info.

#### **Disclaimer**

Unless otherwise specified in the datasheet, the product is designed and qulified as a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability, such as automotive, aviation/aerospace and life-support devices or systems.

Any and all semicondutor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.

CRM(CQ) reserves the right to improve product design, function and reliability without notice.

